

SEM 2 – 5 (RC 07-08)

F.E. (Semester – II) (Revised in 2007-08) Examination, Nov./Dec. 2017
BASIC ELECTRONICS ENGINEERING

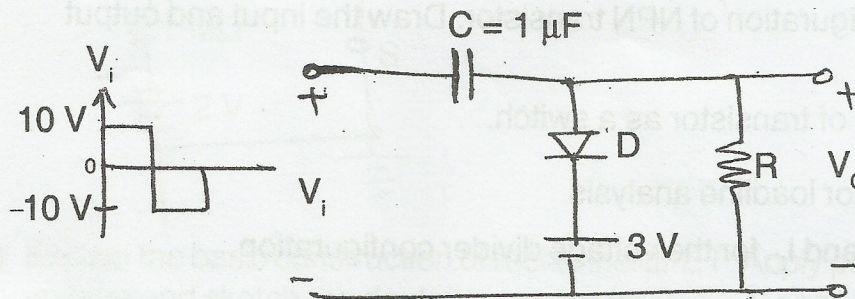
Duration : 3 Hours

Total Marks : 100

- Instructions :** 1) Answer 5 questions choosing atleast **one** from **each** Module.
2) Assume data **if necessary**.

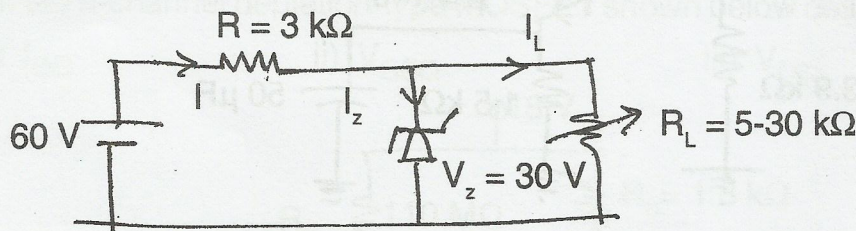
MODULE – I

1. a) Determine the output waveform for the following circuit assuming RC time constant is very large and diode is ideal. 4



- b) Using Zener diode approximations find current through the diode of fig. when load resistance R_L is

- i) $30\text{ k}\Omega$
ii) $5\text{ k}\Omega$. 6



- c) What is a diode and how is the depletion region formed ? 4
d) In a center tap full wave rectifier, $R_L = 1\text{ k}\Omega$ and each diode has a forward biased dynamic resistance $r_f = 10\text{ }\Omega$. The voltage across each half of the secondary winding is $220\sin\omega t$. Determine I_m , I_{dc} , I_{rms} and Ripple factor. 6

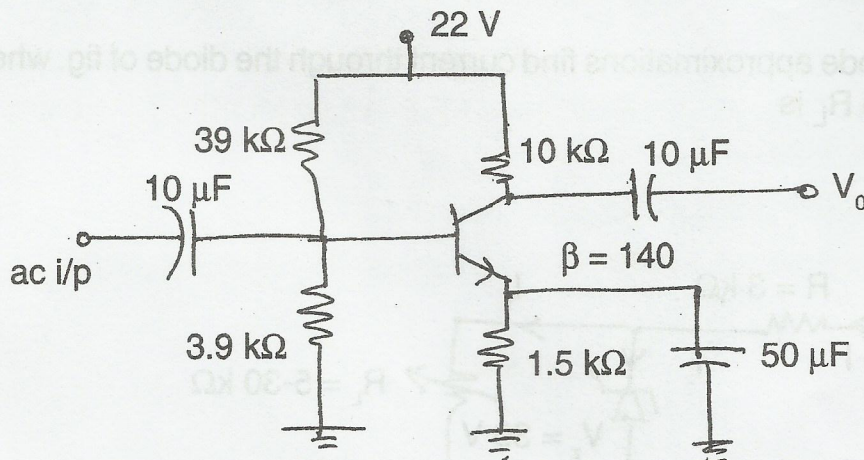
P.T.O.



2. a) Explain the working of Half wave rectifier and derive the expression for Ripple factor and Efficiency. 10
- b) Why is a Filter required in a dc power supply ? Draw the circuit of a C filter and explain the output waveform. 5
- c) Draw and explain the operation of a Half wave voltage doubler. 5

MODULE – II

3. a) What do you mean by stabilization of operating point ? Explain the reasons why stabilization of Q point is necessary. 4
- b) Explain Fixed Bias BJT biasing configuration. 6
- c) Explain CE configuration of NPN transistor. Draw the input and output characteristics. 6
- d) Explain working of transistor as a switch. 4
4. a) Explain Transistor loadline analysis. 5
- b) Determine V_{CE} and I_C for the voltage divider configuration. 5



- c) With the help of circuit diagram and waveforms explain how a transistor works as an amplifier. 5
- d) Explain basic transistor construction. 5

MODULE – III

5. a) Draw and explain the drain to source characteristics of P-channel JFET. Also explain how transfer curve is obtained from the output characteristics. 7



b) For Fixed bias configuration given below, determine the following :

i) V_{GSQ}

ii) I_{DQ}

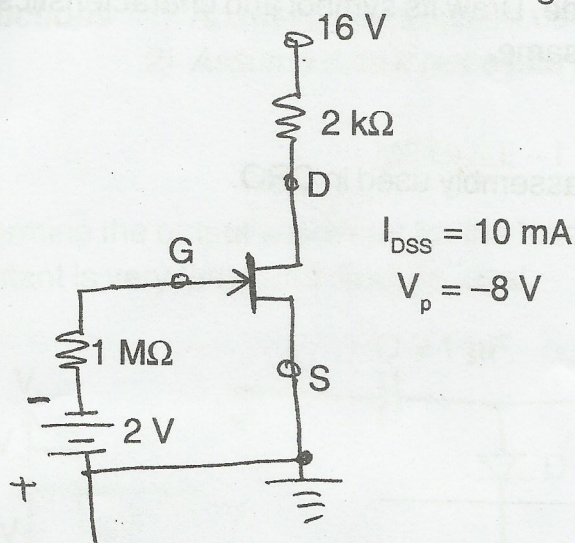
iii) V_{DS}

iv) V_D

v) V_G

vi) V_S

6



c) Explain the basic construction of n-channel JFET. Apply proper drain to source voltage and sketch the depletion region for $V_{GS} = 0$ and V_{DS} at some positive voltages.

7

6. a) Explain construction of n-channel Enhancement type MOSFET. Also draw its drain characteristics.

8

b) Explain how CMOS can be used as an inverter.

5

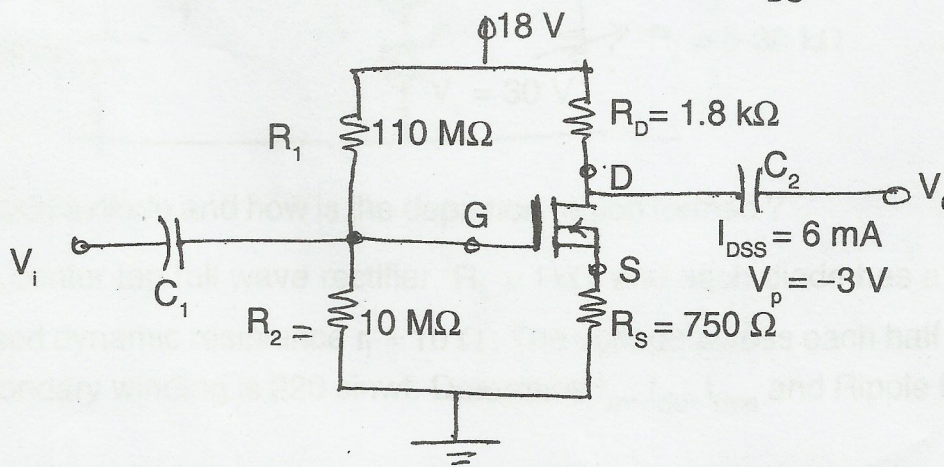
c) For the n-channel depletion-type MOSFET shown below determine :

i) I_{DQ}

ii) V_{GSQ}

iii) V_{DS}

7





MODULE – IV

7. a) Explain the working of dynamic scattering LCD. 7
 b) Explain the working of photo conductive cell. 5
 c) Explain the working of photodiode. Draw its symbol and characteristics and also give one application of the same. 8
8. a) Explain the operation of SCR. 7
 b) Draw and explain Electron gun assembly used in CRO. 5
 c) Write a short note on (any 2) : 8
 i) IR Emitters
 ii) Solar cell
 iii) Thermistor.